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Details

Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	32MHz
Connectivity	I ² C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	18
Program Memory Size	8KB (2.75K x 24)
Program Memory Type	FLASH
EEPROM Size	512 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 16x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	20-DIP (0.300", 7.62mm)
Supplier Device Package	20-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24f08km101-i-p

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TABLE 4-15: UART1 REGISTER MAP

File Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
U1MODE	220h	UARTEN		USIDL	IREN	RTSMD		UEN1	UEN0	WAKE	LPBACK	ABAUD	URXINV	BRGH	PDSEL1	PDSEL0	STSEL	0000
U1STA	222h	UTXISEL1	UTXINV	UTXISEL0		UTXBRK	UTXEN	UTXBF	TRMT	URXISEL1	URXISEL0	ADDEN	RIDLE	PERR	FERR	OERR	URXDA	0110
U1TXREG	224h	_	_	_		_	_	_				UART1 Tra	ansmit Regis	ster				xxxx
U1RXREG	226h	_	_	_		_	_	_	UART1 Receive Register							0000		
U1BRG	228h	Baud Rate Generator Prescaler 0								0000								

Legend: x = unknown, u = unchanged, - = unimplemented, q = value depends on condition, r = reserved.

TABLE 4-16: UART2 REGISTER MAP

File Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
U2MODE ⁽¹⁾	230h	UARTEN	_	USIDL	IREN	RTSMD	—	UEN1	UEN0	WAKE	LPBACK	ABAUD	URXINV	BRGH	PDSEL1	PDSEL0	STSEL	0000
U2STA ⁽¹⁾	232h	UTXISEL1	UTXINV	UTXISEL0	-	UTXBRK	UTXEN	UTXBF	TRMT	URXISEL1	URXISEL0	ADDEN	RIDLE	PERR	FERR	OERR	URXDA	0110
U2TXREG ⁽¹⁾	234h	_	_	_	—	_	_	_				UART2 Tra	nsmit Regis	ster				xxxx
U2RXREG ⁽¹⁾	236h	_	_	_	—	_	_	_	UART2 Receive Register						0000			
U2BRG ⁽¹⁾	238h	Baud Rate Generator Prescaler										0000						

Legend: x = unknown, u = unchanged, - = unimplemented, q = value depends on condition, r = reserved.

Note 1: These registers are available only on PIC24F(V)16KM2XX devices.

6.3 NVM Address Register

As with Flash program memory, the NVM Address registers, NVMADRU and NVMADR, form the 24-bit Effective Address (EA) of the selected row or word for data EEPROM operations. The NVMADRU register is used to hold the upper 8 bits of the EA, while the NVMADR register is used to hold the lower 16 bits of the EA. These registers are not mapped into the Special Function Register (SFR) space; instead, they directly capture the EA<23:0> of the last Table Write instruction that has been executed and select the data EEPROM row to erase. Figure 6-1 depicts the program memory EA that is formed for programming and erase operations.

Like program memory operations, the Least Significant bit (LSb) of NVMADR is restricted to even addresses. This is because any given address in the data EEPROM space consists of only the lower word of the program memory width; the upper word, including the uppermost "phantom byte", are unavailable. This means that the LSb of a data EEPROM address will always be '0'.

Similarly, the Most Significant bit (MSb) of NVMADRU is always '0', since all addresses lie in the user program space.

FIGURE 6-1: DATA EEPROM ADDRESSING WITH TBLPAG AND NVM ADDRESS REGISTERS



6.4 Data EEPROM Operations

The EEPROM block is accessed using Table Read and Write operations, similar to those used for program memory. The TBLWTH and TBLRDH instructions are not required for data EEPROM operations since the memory is only 16 bits wide (data on the lower address is valid only). The following programming operations can be performed on the data EEPROM:

- · Erase one, four or eight words
- Bulk erase the entire data EEPROM
- Write one word
- Read one word

Note 1: Unexpected results will be obtained if the user attempts to read the EEPROM while a programming or erase operation is underway.

2: The XC16 C compiler includes library procedures to automatically perform the Table Read and Table Write operations, manage the Table Pointer and write buffers, and unlock and initiate memory write sequences. This eliminates the need to create assembler macros or time critical routines in C for each application.

The library procedures are used in the code examples detailed in the following sections. General descriptions of each process are provided for users who are not using the XC16 compiler libraries.

7.4.2 SOFTWARE ENABLED BOR

When BOREN<1:0> = 01, the BOR can be enabled or disabled by the user in software. This is done with the control bit, SBOREN (RCON<13>). Setting SBOREN enables the BOR to function as previously described. Clearing the SBOREN disables the BOR entirely. The SBOREN bit operates only in this mode; otherwise, it is read as '0'.

Placing BOR under software control gives the user the additional flexibility of tailoring the application to its environment without having to reprogram the device to change the BOR configuration. It also allows the user to tailor the incremental current that the BOR consumes. While the BOR current is typically very small, it may have some impact in low-power applications.

Note:	Even when the BOR is under software con-
	trol, the Brown-out Reset voltage level is
	still set by the BORV<1:0> Configuration
	bits; it can not be changed in software.

7.4.3 DETECTING BOR

When BOR is enabled, the BOR bit (RCON<1>) is always reset to '1' on any BOR or POR event. This makes it difficult to determine if a BOR event has occurred just by reading the state of BOR alone. A more reliable method is to simultaneously check the state of both POR and BOR. This assumes that the POR and BOR bits are reset to '0' in the software immediately after any POR event. If the BOR bit is '1' while POR is '0', it can be reliably assumed that a BOR event has occurred.

7.4.4 DISABLING BOR IN SLEEP MODE

When BOREN<1:0> = 10, BOR remains under hardware control and operates as previously described. However, whenever the device enters Sleep mode, BOR is automatically disabled. When the device returns to any other operating mode, BOR is automatically re-enabled.

This mode allows for applications to recover from brown-out situations, while actively executing code, when the device requires BOR protection the most. At the same time, it saves additional power in Sleep mode by eliminating the small incremental BOR current.

Note: BOR levels differ depending on device type; PIC24FV16KM204 devices are at different levels than those of PIC24F16KM204 devices. See Section 27.0 "Electrical Characteristics" for BOR voltage levels.

REGISTER 8-3: INTCON1: INTERRUPT CONTROL REGISTER 1

R/W-0	U-0						
NSTDIS	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	U-0	R/W-0, HS	R/W-0, HS	R/W-0, HS	R/W-0, HS	U-0
—	—	—	MATHERR	ADDRERR	STKERR	OSCFAIL	—
bit 7							bit 0

Legend:		HS = Hardware Settable bi	t	
R = Readabl	e bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at	POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown
bit 15	NSTDIS: Inte	errupt Nesting Disable bit		
	1 = Interrupt 0 = Interrupt	nesting is disabled nesting is enabled		
bit 14-5	Unimplemen	nted: Read as '0'		
bit 4	MATHERR: A	Arithmetic Error Trap Status I	bit	
	1 = Overflow 0 = Overflow	trap has occurred trap has not occurred		
bit 3	ADDRERR: /	Address Error Trap Status bit	t	
	1 = Address 0 = Address	error trap has occurred error trap has not occurred		
bit 2	STKERR: Sta	ack Error Trap Status bit		
	1 = Stack erro 0 = Stack erro	or trap has occurred or trap has not occurred		
bit 1	OSCFAIL: O	scillator Failure Trap Status I	bit	
	1 = Oscillator 0 = Oscillator	r failure trap has occurred r failure trap has not occurred	t	
bit 0	Unimplemen	nted: Read as '0'		

8.4 Interrupt Setup Procedures

8.4.1 INITIALIZATION

To configure an interrupt source:

- 1. Set the NSTDIS control bit (INTCON1<15>) if nested interrupts are not desired.
- Select the user-assigned priority level for the interrupt source by writing the control bits in the appropriate IPCx register. The priority level will depend on the specific application and type of interrupt source. If multiple priority levels are not desired, the IPCx register control bits for all enabled interrupt sources may be programmed to the same non-zero value.

Note: At a device Reset, the IPCx registers are initialized, such that all user interrupt sources are assigned to Priority Level 4.

- 3. Clear the interrupt flag status bit associated with the peripheral in the associated IFSx register.
- 4. Enable the interrupt source by setting the interrupt enable control bit associated with the source in the appropriate IECx register.

8.4.2 INTERRUPT SERVICE ROUTINE

The method that is used to declare an ISR (Interrupt Service Routine) and initialize the IVT with the correct vector address depends on the programming language (i.e., C or assembly), and the language development toolsuite that is used to develop the application. In general, the user must clear the interrupt flag in the appropriate IFSx register for the source of the interrupt that the ISR handles. Otherwise, the ISR will be re-entered immediately after exiting the routine. If the ISR is coded in assembly language, it must be terminated using a RETFIE instruction to unstack the saved PC value, SRL value and old CPU priority level.

8.4.3 TRAP SERVICE ROUTINE (TSR)

A Trap Service Routine (TSR) is coded like an ISR, except that the appropriate trap status flag in the INTCON1 register must be cleared to avoid re-entry into the TSR.

8.4.4 INTERRUPT DISABLE

All user interrupts can be disabled using the following procedure:

- 1. Push the current SR value onto the software stack using the PUSH instruction.
- 2. Force the CPU to Priority Level 7 by inclusive ORing the value, 0Eh, with SRL.

To enable user interrupts, the POP instruction may be used to restore the previous SR value.

Only user interrupts with a priority level of 7 or less can be disabled. Trap sources (Levels 8-15) cannot be disabled.

The DISI instruction provides a convenient way to disable interrupts of Priority Levels 1-6 for a fixed period. Level 7 interrupt sources are not disabled by the DISI instruction.

9.3 Control Registers

The operation of the oscillator is controlled by three Special Function Registers (SFRs):

- OSCCON
- CLKDIV
- OSCTUN

The OSCCON register (Register 9-1) is the main control register for the oscillator. It controls clock source switching and allows the monitoring of clock sources.

The Clock Divider register (Register 9-2) controls the features associated with Doze mode, as well as the postscaler for the FRC Oscillator.

The FRC Oscillator Tune register (Register 9-3) allows the user to fine-tune the FRC Oscillator over a range of approximately $\pm 5.25\%$. Each bit increment or decrement changes the factory calibrated frequency of the FRC Oscillator by a fixed amount.

REGISTER 9-1: OSCCON: OSCILLATOR CONTROL REGISTER

U-0	R-0, HSC	R-0, HSC	R-0, HSC	U-0	R/W-x ⁽¹⁾	R/W-x ⁽¹⁾	R/W-x ⁽¹⁾
—	COSC2	COSC1	COSC0	—	NOSC2	NOSC1	NOSC0
bit 15							bit 8

R/SO-0, HSC	U-0	R-0, HSC ⁽²⁾	U-0	R/CO-0, HS	R/W-0 ⁽³⁾	R/W-0	R/W-0
CLKLOCK	—	LOCK	—	CF	SOSCDRV	SOSCEN	OSWEN
bit 7							bit 0

Legend:	HSC = Hardware Settable/Clearable bit				
HS = Hardware Settable bit	CO = Clearable Only bit	SO = Settable Only bit			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 15	Unimplemented: Read as '0'							
bit 14-12	COSC<2:0>: Current Oscillator Selection bits							
	 111 = 8 MHz Fast RC Oscillator with Postscaler (FRCDIV) 110 = 500 kHz Low-Power Fast RC Oscillator (FRC) with Postscaler (LPFRCDIV) 101 = Low-Power RC Oscillator (LPRC) 100 = Secondary Oscillator (SOSC) 011 = Primary Oscillator with PLL module (XTPLL, HSPLL, ECPLL) 010 = Primary Oscillator (XT, HS, EC) 001 = 8 MHz FRC Oscillator with Postscaler and PLL module (FRCPLL) 000 = 8 MHz FRC Oscillator (FRC) 							
bit 11	Unimplemented: Read as '0'							
bit 10-8	NOSC<2:0>: New Oscillator Selection bits ⁽¹⁾							
	111 = 8 MHz Fast RC Oscillator with Postscaler (FRCDIV)							
	110 = 500 kHz Low-Power Fast RC Oscillator (FRC) with Postscaler (LPFRCDIV)							
	101 = Low-Power RC Oscillator (LPRC)							
	100 = Secondary Oscillator (SOSC)							
	011 = Primary Oscillator with PLL module (XTPLL, HSPLL, ECPLL)							
	010 = Primary Oscillator (XT, HS, EC)							
	001 = 8 MHz FRC Oscillator with Postscaler and PLL module (FRCPLL)							
	000 = 8 MHz FRC Oscillator (FRC)							
Note 1:	Reset values for these bits are determined by the FNOSCx Configuration bits.							
2:	This bit also resets to '0' during any valid clock switch or whenever a non-PLL Clock mode is selected.							

3: When SOSC is selected to run from a digital clock input, rather than an external crystal (SOSCSRC = 0), this bit has no effect.

R/W-0	R/W-0	R/W-1	R/W-1	R/W-0	R/W-0	R/W-0	R/W-1			
ROI	DOZE2	DOZE1	DOZE0	DOZEN ⁽¹⁾	RCDIV2	RCDIV1	RCDIV0			
bit 15					•	· · · · · ·	bit 8			
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0			
	—	—	—	—	—	—	—			
bit 7							bit 0			
Legend:										
R = Readable	e bit	W = Writable	bit	U = Unimplem	nented bit, read	l as '0'				
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	own			
bit 15	ROI: Recover 1 = Interrupts 0 = Interrupts	on Interrupt bi clear the DOZ have no effect	t EN bit, and res t on the DOZE	set the CPU an N bit	d peripheral clo	ock ratio to 1:1				
bit 14-12	DOZE<2:0>: 111 = 1:128 110 = 1:64 101 = 1:32 100 = 1:16 011 = 1:8 010 = 1:4 001 = 1:2 000 = 1:1	CPU and Perip	heral Clock Ra	atio Select bits						
bit 11	DOZEN: Doze	e Enable bit ⁽¹⁾								
	1 = DOZE<2 0 = CPU and	:0> bits specify peripheral cloc	the CPU and p k ratio are set	peripheral clock to 1:1	< ratio					
bit 10-8	RCDIV<2:0>:	FRC Postscale	er Select bits							
bit 10-0	DOZEN: Doze Enable bit ⁽¹⁾ 1 = DOZE<2:0> bits specify the CPU and peripheral clock ratio 0 = CPU and peripheral clock ratio are set to 1:1 RCDIV<2:0>: FRC Postscaler Select bits When $COSC<2:0> (OSCCON<14:12>) = 111:$ 111 = 31.25 kHz (divide-by-256) 110 = 125 kHz (divide-by-64) 101 = 250 kHz (divide-by-32) 100 = 500 kHz (divide-by-46) 011 = 1 MHz (divide-by-16) 011 = 1 MHz (divide-by-4) 001 = 4 MHz (divide-by-4) 001 = 4 MHz (divide-by-2) – default 000 = 8 MHz (divide-by-266) 110 = 7.81 kHz (divide-by-266) 110 = 7.81 kHz (divide-by-16) 011 = 15.62 kHz (divide-by-16) 011 = 62.5 kHz (divide-by-4) 010 = 125 kHz (divide-by-4) 010 = 125 kHz (divide-by-4) 010 = 125 kHz (divide-by-2) – default									
bit 7-0	Unimplemen	ted: Read as 'o)'							

REGISTER 9-2: CLKDIV: CLOCK DIVIDER REGISTER

Note 1: This bit is automatically cleared when the ROI bit is set and an interrupt occurs.

REGISTER 10-1: ULPWCON: ULPWU CONTROL REGISTER

R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	R/W-0		
ULPEN	_	ULPSIDL		—	—	—	ULPSINK		
bit 15				-			bit 8		
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
—	—	—		—	—	—	—		
bit 7							bit 0		
Legend:									
R = Readabl	le bit	W = Writable b	pit	U = Unimplemented bit, read as '0'					
-n = Value at	POR	'1' = Bit is set		'0' = Bit is cleared x = Bit is unknown			nown		
bit 15	ULPEN: ULF	PWU Module En	able bit						
	1 = Module is	s enabled							
	0 = Module is	s disabled							
bit 14	Unimplemer	nted: Read as '	י)						
bit 13	ULPSIDL: U	LPWU Stop in Id	dle Select bit						
	1 = Discontin	ues module ope	eration when the	e device enters	Idle mode				
	0 = Continue	s module opera	tion in Idle mod	e					
bit 12-9	Unimplemer	nted: Read as ')'						
bit 8	ULPSINK: U	LPWU Current	Sink Enable bit						
	1 = Current s	sink is enabled							
	0 = Current s	sink is disabled							
bit 7-0	Unimplemer	nted: Read as 'o)'						

11.2.2 I/O PORT WRITE/READ TIMING

One instruction cycle is required between a port direction change or port write operation, and a read operation of the same port. Typically, this instruction would be a NOP.

11.3 Input Change Notification (ICN)

The Input Change Notification function of the I/O ports allows the PIC24FXXXXX family of devices to generate interrupt requests to the processor in response to a Change-of-State (COS) on selected input pins. This feature is capable of detecting input Change-of-States, even in Sleep mode, when the clocks are disabled. Depending on the device pin count, there are up to 37 external signals (CN0 through CN36) that may be selected (enabled) for generating an interrupt request on a Change-of-State.

There are six control registers associated with the CN module. The CNEN1 and CNEN3 registers contain the interrupt enable control bits for each of the CNx input pins. Setting any of these bits enables a CN interrupt for the corresponding pins.

Each CNx pin also has a weak pull-up/pull-down connected to it. The pull-ups act as a current source that is connected to the pin. The pull-downs act as a current sink to eliminate the need for external resistors when push button or keypad devices are connected.

On any pin, only the pull-up resistor or the pull-down resistor should be enabled, but not both of them. If the push button or the keypad is connected to VDD, enable the pull-down, or if they are connected to VSS, enable the pull-up resistors. The pull-ups are enabled separately using the CNPU1 and CNPU3 registers, which contain the control bits for each of the CNx pins.

Setting any of the control bits enables the weak pull-ups for the corresponding pins. The pull-downs are enabled separately using the CNPD1 and CNPD3 registers, which contain the control bits for each of the CNx pins. Setting any of the control bits enables the weak pull-downs for the corresponding pins.

When the internal pull-up is selected, the pin uses VDD as the pull-up source voltage. When the internal pull-down is selected, the pins are pulled down to Vss by an internal resistor. Make sure that there is no external pull-up source/pull-down sink when the internal pull-ups/pull-downs are enabled.

Note: Pull-ups and pull-downs on Change Notification (CN) pins should always be disabled whenever the port pin is configured as a digital output.

EXAMPLE 11-1: PORT WRITE/READ EXAMPLE

MOV 0xFF00, W0; MOV W0, TRISB;	//Configure PORTB<15:8> as inputs and PORTB<7:0> as outputs
NOP;	//Delay 1 cycle
BTSS PORTB, #13;	//Next Instruction
<pre>Equivalent `C' Code TRISB = 0xFF00; NOP(); if(PORTBbits.RB13 == 1) { }</pre>	//Configure PORTB<15:8> as inputs and PORTB<7:0> as outputs //Delay 1 cycle // execute following code if PORTB pin 13 is set.

SYNC<4:0>	Synchronization Source
00000	None; Timer with Rollover on CCPxPR Match or FFFFh
00001	MCCP1 or SCCP1 Sync Output
00010	MCCP2 or SCCP2 Sync Output
00011	MCCP3 or SCCP3 Sync Output
00100	MCCP4 or SCCP4 Sync Output
00101	MCCP5 or SCCP5 Sync Output
00110 to 01010	Unused
01011	Timer1 Sync Output ⁽¹⁾
01100 to 10000	Unused
10001	CLC1 Output ⁽¹⁾
10010	CLC2 Output ⁽¹⁾
10011 to 11010	Unused
11011	A/D ⁽¹⁾
11110	Unused
11111	None; Timer with Auto-Rollover (FFFFh \rightarrow 0000h)

TABLE 13-6: SYNCHRONIZATION SOURCES

Note 1: These sources are only available when the source module is being used in a Synchronous mode.

R/W-0	R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	
PWMRSEN	ASDGM	—	SSDG	_	—	_		
bit 15		·		·	·		bit 8	
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
ASDG7	ASDG6	ASDG5	ASDG4	ASDG3	ASDG2	ASDG1	ASDG0	
bit 7							bit 0	
Legend:								
R = Readable	bit	W = Writable	bit	U = Unimplem	nented bit, read	l as '0'		
-n = Value at F	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown	
bit 15 bit 14 bit 13	 PWMRSEN: CCPx PWM Restart Enable bit 1 = ASEVT bit clears automatically at the beginning of the next PWM period, after the shutdown input has ended 0 = ASEVT bit must be cleared in software to resume PWM activity on output pins ASDGM: CCPx Auto-Shutdown Gate Mode Enable bit 1 = Wait until the next Time Base Reset or rollover for shutdown to occur 0 = Shutdown event occurs immediately 							
bit 10		Software Shut	, down/Cato Ca	ntral hit				
UIL IZ	 SSDG: CCPx Software Shutdown/Gate Control bit 1 = Manually force auto-shutdown, timer clock gate or input capture signal gate event (setting of ASDGM bit still applies) 0 = Normal module operation 							
bit 11-8	Unimplemen	ted: Read as ')'					
bit 7-0	ASDG<7:0>:	CCPx Auto-Sh	utdown/Gating	g Source Enable	e bits			
	1 = ASDGx S 0 = ASDGx S	Source n is ena Source n is disa	bled (see Tabl bled	e 13-7 for auto-	shutdown/gatir	ng sources)		

REGISTER 13-3: CCPxCON2L: CCPx CONTROL 2 LOW REGISTERS

TABLE 13-7: AUTO-SHUTDOWN AND GATING SOURCES

ASDG<7:0> Bits	Auto-Shutdown/Gating Source
0	Comparator 1 Output
1	Comparator 2 Output
2	Comparator 3 Output
3	SCCP4 Output Compare
4	SCCP5 Output Compare
5	CLC1 Output
6	OCFA Fault Input
7	OCFB Fault Input

'1' = Bit is set

REGISTER 14-8: SSPxADD: MSSPx SLAVE ADDRESS/BAUD RATE GENERATOR REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADD7	ADD6	ADD5	ADD4	ADD3	ADD2	ADD1	ADD0
bit 7							bit 0
Legend:							
R = Readable bit		W = Writable	bit	U = Unimpler	nented bit, read	d as '0'	

'0' = Bit is cleared

x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

-n = Value at POR

 bit 7-0
 ADD<7:0>: Slave Address/Baud Rate Generator Value bits

 SPI Master and I²C™ Master modes:
 Reload value for the Baud Rate Generator. Clock period is (([SPxADD] + 1) * 2)/Fosc.

 I²C Slave modes:
 Represents 7 or 8 bits of the slave address, depending on the addressing mode used:

 7-Bit mode:
 Address is ADD<7:1>; ADD<0> is ignored.

 10-Bit LSb mode:
 ADD<7:0> are the Least Significant bits of the address.

 10-Bit MSb mode:
 ADD<2:1> are the two Most Significant bits of the address; ADD<7:3> are always '11110' as a specification requirement; ADD<0> is ignored.

REGISTER 14-9: SSPxMSK: I²C[™] SLAVE ADDRESS MASK REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	—	—	—	—	—	
bit 15							bit 8

| R/W-1 |
|-------|-------|-------|-------|-------|-------|-------|---------------------|
| MSK7 | MSK6 | MSK5 | MSK4 | MSK3 | MSK2 | MSK1 | MSK0 ⁽¹⁾ |
| bit 7 | | | | | | | bit 0 |

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15-8	Unimplemented: Read as '0'
bit 7-0	MSK<7:0>: Slave Address Mask Select bits ⁽¹⁾
	1 = Masking of corresponding bit of SSPxADD is enabled
	0 = Masking of corresponding bit of SSPxADD is disabled

Note 1: MSK0 is not used as a mask bit in 7-bit addressing.

16.2.5 RTCVAL REGISTER MAPPINGS

REGISTER 16-4: YEAR: YEAR VALUE REGISTER⁽¹⁾

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15			•				bit 8

| R/W-x |
|--------|--------|--------|--------|--------|--------|--------|--------|
| YRTEN3 | YRTEN2 | YRTEN1 | YRTEN0 | YRONE3 | YRONE2 | YRONE1 | YRONE0 |
| bit 7 | | | | | | | bit 0 |

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15-8 Unimplemented: Read as '0'

- bit 7-4 **YRTEN<3:0>:** Binary Coded Decimal Value of Year's Tens Digit bits Contains a value from 0 to 9.
- bit 3-0 **YRONE<3:0>:** Binary Coded Decimal Value of Year's Ones Digit bits Contains a value from 0 to 9.

Note 1: A write to the YEAR register is only allowed when RTCWREN = 1.

REGISTER 16-5: MTHDY: MONTH AND DAY VALUE REGISTER⁽¹⁾

U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	—	MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0
bit 15							bit 8

U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	DAYTEN1	DAYTEN0	DAYONE3	DAYONE2	DAYONE1	DAYONE0
bit 7							bit 0

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15-13 Unimplemented: Read as '0'

- bit 12 **MTHTENO:** Binary Coded Decimal Value of Month's Tens Digit bit Contains a value of '0' or '1'.
- bit 11-8 MTHONE<3:0>: Binary Coded Decimal Value of Month's Ones Digit bits Contains a value from 0 to 9.
- bit 7-6 Unimplemented: Read as '0'
- bit 5-4 **DAYTEN<1:0>:** Binary Coded Decimal Value of Day's Tens Digit bits Contains a value from 0 to 3.
- bit 3-0 **DAYONE<3:0>:** Binary Coded Decimal Value of Day's Ones Digit bits Contains a value from 0 to 9.

Note 1: A write to this register is only allowed when RTCWREN = 1.

17.1 Control Registers

The CLCx module is controlled by the following registers:

- CLCxCONL
- CLCxCONH
- CLCxSEL
- CLCxGLSL
- CLCxGLSH

The CLCx Control registers (CLCxCONL and CLCxCONH) are used to enable the module and interrupts, control the output enable bit, select output polarity and select the logic function. The CLCx Control registers also allow the user to control the logic polarity of not only the cell output, but also some intermediate variables. The CLCx Source Select register (CLCxSEL) allows the user to select up to 4 data input sources using the 4 data input selection multiplexers. Each multiplexer has a list of 8 data sources available.

The CLCx Gate Logic Select registers (CLCxGLSL and CLCxGLSH) allow the user to select which outputs from each of the selection MUXes are used as inputs to the input gates of the logic cell. Each data source MUX outputs both a true and a negated version of its output. All of these 8 signals are enabled, ORed together by the logic cell input gates.

REGISTER 17-1: CLCxCONL: CLCx CONTROL REGISTER (LOW)

R/W-0	U-0	U-0	U-0	R/W-0	R/W-0	U-0	U-0
LCEN		<u> </u>		INTP	INTN		
bit 15							bit 8
R-0	R-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0
LCOE	LCOUT	LCPOL	—	—	MODE2	MODE1	MODE0
bit 7							bit 0
Legend:							
R = Readab	le bit	W = Writable b	bit	U = Unimplen	nented bit, read	l as '0'	
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	iown
bit 15	LCEN: CLCx	Enable bit					
	1 = CLCx is $0 = CLCx$ is 0	enabled and mix	king input sign s loaic zero o	ials utputs			
bit 14-12	Unimplemen	ted: Read as '0	,				
bit 11	INTP: CLCx F	Positive Edge In	terrupt Enable	e bit			
	1 = Interrupt	will be generate	d when a risir	ng edge occurs	on LCOUT		
	0 = Interrupt	will not be gene	rated				
bit 10	INTN: CLCx I	Negative Edge I	nterrupt Enab	le bit			
	1 = Interrupt 0 = Interrupt	will be generate will not be gene	ed when a falli rated	ng edge occurs	s on LCOUT		
bit 9-8	Unimplemen	ted: Read as '0	,				
bit 7	LCOE: CLCx	Port Enable bit					
	1 = CLCx por	t pin output is e	nabled				
	0 = CLCx por	t pin output is d	isabled				
bit 6	LCOUT: CLC	x Data Output S	status bit				
	1 = CLCx out	put high					
bit 5		y Output Polarit	v Control hit				
bit 0	1 = The outp	ut of the module	e is inverted				
	0 = The outp	ut of the module	e is not inverte	ed			
bit 4-3	Unimplemen	ted: Read as '0	,				

REGISTER 19-8: AD1CSSH: A/D INPUT SCAN SELECT REGISTER (HIGH WORD)	(1)
--	-----

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0
_	CSS30	CSS29	CSS28	CSS27	CSS26	—	—
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CSS23	CSS22	CSS21	CSS20 ⁽²⁾	CSS19 ⁽²⁾	CSS18	CSS17	CSS16
bit 7							bit 0

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

'0'	
	'0'

- bit 14-10CSS<30:26>: A/D Input Scan Selection bits1 = Includes the corresponding channel for input scan0 = Skips the channel for input scanbit 9-8Unimplemented: Read as '0'bit 7-0CSS<23:16>: A/D Input Scan Selection bits⁽²⁾1 = Includes the corresponding channel for input scan0 = Skips the channel for input scan
- **Note 1:** Unimplemented channels are read as '0'. Do not select unimplemented channels for sampling as indeterminate results may be produced.
 - 2: The CSS<20:19> bits are not implemented in 20-pin devices.

REGISTER 19-9: AD1CSSL: A/D INPUT SCAN SELECT REGISTER (LOW WORD)⁽¹⁾

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CSS15	CSS14	CSS13	CSS12	CSS11	CSS10	CSS9	CSS8 ^(2,3)
bit 15	•		•	•			bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CSS7 ^(2,3)	CSS6 ^(2,3)	CSS5 ⁽²⁾	CSS4	CSS3	CSS2	CSS1	CSS0
bit 7							bit 0

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15-0 CSS<15:0>: A/D Input Scan Selection bits^(2,3)

1 = Includes the corresponding ANx input for scan

- 0 = Skips the channel for input scan
- **Note 1:** Unimplemented channels are read as '0'. Do not select unimplemented channels for sampling as indeterminate results may be produced.
 - 2: The CSS<8:5> bits are not implemented in 20-pin devices.
 - 3: The CSS<8:6> bits are not implemented in 28-pin devices.

REGISTER 25-4: FOSC: OSCILLATOR CONFIGURATION REGISTER

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
FCKSM1	FCKSM0	SOSCSEL	POSCFREQ1	POSCFREQ0	OSCIOFNC	POSCMD1	POSCMD0
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6	FCKSM<1:0>: Clock Switching and Fail-Safe Clock Monitor Selection Configuration bits 1x = Clock switching is disabled, Fail-Safe Clock Monitor is disabled 01 = Clock switching is enabled, Fail-Safe Clock Monitor is disabled 00 = Clock switching is enabled, Fail-Safe Clock Monitor is enabled
bit 5	SOSCSEL: Secondary Oscillator Power Selection Configuration bit 1 = Secondary Oscillator is configured for high-power operation 0 = Secondary Oscillator is configured for low-power operation
bit 4-3	POSCFREQ<1:0>: Primary Oscillator Frequency Range Configuration bits 11 = Primary Oscillator/External Clock input frequency is greater than 8 MHz 10 = Primary Oscillator/External Clock input frequency is between 100 kHz and 8 MHz 01 = Primary Oscillator/External Clock input frequency is less than 100 kHz 00 = Reserved; do not use
bit 2	 OSCIOFNC: CLKO Enable Configuration bit 1 = CLKO output signal is active on the OSCO pin; Primary Oscillator must be disabled or configured for the External Clock (EC) mode for the CLKO to be active (POSCMD<1:0> = 11 or 00) 0 = CLKO output is disabled
bit 1-0	POSCMD<1:0>: Primary Oscillator Configuration bits 11 = Primary Oscillator mode is disabled 10 = HS Oscillator mode is selected 01 = XT Oscillator mode is selected

00 = External Clock mode is selected

26.11 Demonstration/Development Boards, Evaluation Kits and Starter Kits

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM[™] and dsPICDEM[™] demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, KEELOQ[®] security ICs, CAN, IrDA[®], PowerSmart battery management, SEEVAL[®] evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Also available are starter kits that contain everything needed to experience the specified device. This usually includes a single application and debug capability, all on one board.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

26.12 Third-Party Development Tools

Microchip also offers a great collection of tools from third-party vendors. These tools are carefully selected to offer good value and unique functionality.

- Device Programmers and Gang Programmers from companies, such as SoftLog and CCS
- Software Tools from companies, such as Gimpel and Trace Systems
- Protocol Analyzers from companies, such as Saleae and Total Phase
- Demonstration Boards from companies, such as MikroElektronika, Digilent[®] and Olimex
- Embedded Ethernet Solutions from companies, such as EZ Web Lynx, WIZnet and IPLogika[®]

	21-31.		Standard Onera	ting Ca	nditions: 1 9\/++	2 6\//			
AC CHARACTERISTICS		Standard Operating Conditions: 1.8V t 2.0V t Operating temperature -40°C -40°C		o 3.6V (PIC24F16KM204) o 5.5V (PIC24FV16KM204) \leq TA \leq +85°C for Industrial \leq TA \leq +125°C for Extended					
Param No.	Symbol	Characteristic	Min.	Тур	Max.	Units	Conditions		
	Device Supply								
AD01	AVDD	Module VDD Supply	Greater of: VDD – 0.3 or 1.8	_	Lesser of: VDD + 0.3 or 3.6	V	PIC24FXXKMXXX devices		
			Greater of: VDD – 0.3 or 2.0		Lesser of: VDD + 0.3 or 5.5	V	PIC24FVXXKMXXX devices		
AD02	AVss	Module Vss Supply	Vss – 0.3	_	Vss + 0.3	V			
			Reference	e Input	S				
AD05	VREFH	Reference Voltage High	AVss + 1.7	_	AVDD	V			
AD06	VREFL	Reference Voltage Low	AVss	_	AVDD – 1.7	V			
AD07	Vref	Absolute Reference Voltage	AVss – 0.3		AVDD + 0.3	V			
AD08	IVREF	Reference Voltage Input Current	_	1.25	_	mA			
AD09	ZVREF	Reference Input Impedance	—	10k	—	Ω			
	•		Analog	Input					
AD10	VINH-VINL	Full-Scale Input Span	VREFL		VREFH	V	(Note 2)		
AD11	Vin	Absolute Input Voltage	AVss - 0.3	_	AVDD + 0.3	V			
AD12	VINL	Absolute VINL Input Voltage	AVss – 0.3		AVDD/2	V			
AD17	Rin	Recommended Impedance of Analog Voltage Source	_	_	1k	Ω	12-bit		
			A/D Acc	uracy					
AD20b	NR	Resolution	—	12	—	bits			
AD21b	INL	Integral Nonlinearity	—	±1	±9	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 5V		
AD22b	DNL	Differential Nonlinearity	—	±1	±5	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 5V		
AD23b	Gerr	Gain Error	—	±1	±9	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 5V		
AD24b	EOFF	Offset Error	_	±1	±5	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 5V		
AD25b		Monotonicity ⁽¹⁾	—	—	_		Guaranteed		
				-					

TABLE 27-37: A/D MODULE SPECIFICATIONS

 $\label{eq:Note_1:} \textbf{Note_1:} \quad \text{The A/D conversion result never decreases with an increase in the input voltage.}$

2: Measurements are taken with external VREF+ and VREF- used as the A/D voltage reference.

20-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



TOP VIEW





VIEW A-A

Microchip Technology Drawing C04-094C Sheet 1 of 2

28-Lead Plastic Quad Flat, No Lead Package (ML) – 6x6 mm Body [QFN] with 0.55 mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS			
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.65 BSC		
Optional Center Pad Width	W2			4.25
Optional Center Pad Length	T2			4.25
Contact Pad Spacing	C1		5.70	
Contact Pad Spacing	C2		5.70	
Contact Pad Width (X28)	X1			0.37
Contact Pad Length (X28)	Y1			1.00
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2105A